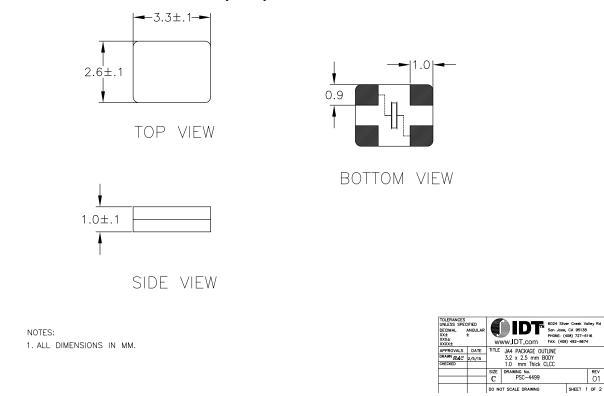


### **DATASHEET**

# **Specifications**

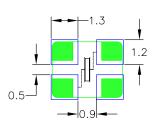
Parameters	Ratings/Units			
Frequency	38.880 MHz			
Resonance Mode	Fundamental			
Frequency Tolerance @ 25°C	±20 PPM Max			
Frequency Stability, ref @ 25°C Over Operating Temperature Range	±20 PPM Max			
Temperature Range, Operating (TOPR)	-40°C ~ +85°C			
Temperature Range, Storage (TSTG)	-40°C ~ +85°C			
Equivalent Series Resistance (ESR)	30 Ohms Max			
Shunt Capacitance (Co)	5 pF Max			
Load Capacitance (CL)	12 pF			
Drive Level	0.3 mW Max			
Aging over 10 years	±10 PPM Max			
Maximum Soldering Temp / Time	260°C / 10 Seconds			
Moisture Sensitivity Level (MSL)	1			
Termination Finish:	Au			
Weight (TYP)	16.75 mg			
RoHS Compliant, Pb-free				

# Package Outline and Dimensions (JA4)





## Package Outline and Dimensions (JA4), cont.



RECOMMENDED LAND PATTERN

### NOTES:

- 1. ALL DIMENSION ARE IN mm. ANGLES IN DEGREES.
  2. TOP DOWN VIEW. AS VIEWED ON PCB.
  3. COMPONENT OUTLINE SHOW FOR REFERENCE IN GREEN.
  4. LAND PATTERN IN BLUE. NSMD PATTERN ASSUMED.
  5. LAND PATTERN RECOMMENDATION PER IPC—7351B GENERIC REQUIREMENT FOR SURFACE MOUNT DESIGN AND LAND PATTERN.

TOLERANCES UNLESS SPE DECIMAL XX± XXX± XXXX±		w w	IDT*	San Jose, PHONE: (4	er Creek Vo CA 95138 08) 727-6 ) 492-8674	116
APPROVALS	DATE	TITLE	JA4 PACKAGE OUT	TLINE		
DRAWN RAC	2/5/15	3.2 x 2.5 mm B0DY				
CHECKED		1.0 mm Thick CLCC				
		SIZE	DRAWING No.			REV
		C	PSC-4499			01
		DO NO	OT SCALE DRAWING		SHEET 2	0F 2

## **Ordering Information**

Part / Order Number	Shipping Packaging	Package	Temperature
603-38.88-7JA4I	Cut-Tape	3.2 x 2.5 x 1.0 mm JA4 CLCC	-40 to +85 °C
603-38.88-7JA4I8	Tape and Reel	3.2 x 2.5 x 1.0 mm JA4 CLCC	-40 to +85 °C

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